

Electronic Patent Application Fee Transmittal

Application Number:	10512405
Filing Date:	15-Jun-2005
Title of Invention:	HIGH RESISTANCE SILICON WAFER AND ITS MANUFACTURING METHOD
First Named Inventor/Applicant Name:	Nobumitsu Takase
Filer:	Bradley J. Meier/Natherine Oranza
Attorney Docket Number:	474082002800

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Utility Appl Issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	6	3	18
Total in USD (\$)				1758